


J21 SHALL HAVE PIN 6 REMOVED

- JP2 AND JP4 SHALL BE POPULATED WITH JUMPERS

- (8) MOUNTING HOLES SHALL HAVE  
4-40 SCREW WITH STANDOFF

ASSEMBLY TOP

	TITLE Texas Instruments		
	ASSY, DRV8301/DRV8302EVM HIGH CURRENT EVM		
DWG B SIZE	ITEM NO. 515501	REV D	
DRAWN BY: AKS	APPROVED BY: JPW	DATE: 08/23/11	
SCALE 1/1		SHT 1 OF 1	

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